

MJF44H11 (NPN), MJF45H11 (PNP)

Preferred Devices

Complementary Power Transistors

For Isolated Package Applications

Complementary power transistors are for general purpose power amplification and switching such as output or driver stages in applications such as switching regulators, converters and power amplifiers.

Features

- Low Collector-Emitter Saturation Voltage –
 $V_{CE(sat)} = 1.0 \text{ V (Max) @ } 8.0 \text{ A}$
- Fast Switching Speeds
- Complementary Pairs Simplifies Designs
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	80	Vdc
Emitter-Base Voltage	V_{EB}	5	Vdc
Collector Current – Continuous – Peak	I_C	10 20	Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	36 1.67	W W/ $^\circ\text{C}$
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	2.0 0.016	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.5	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

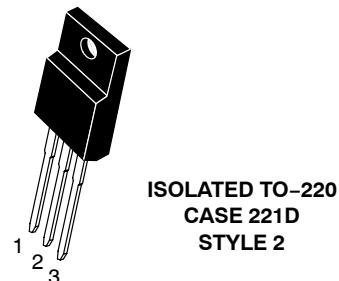
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



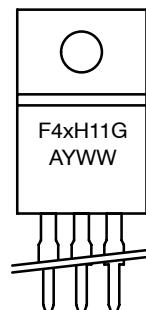
ON Semiconductor®

<http://onsemi.com>

SILICON POWER TRANSISTORS
10 AMPERES
80 VOLTS, 36 WATTS



MARKING DIAGRAM



F4xH11 = Specific Device Code
x = 4 or 5
G = Pb-Free Package
A = Assembly Location
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MJF44H11	TO-220 FULLPACK	50 Units/Rail
MJF44H11G	TO-220 FULLPACK (Pb-Free)	50 Units/Rail
MJF45H11	TO-220 FULLPACK	50 Units/Rail
MJF45H11G	TO-220 FULLPACK (Pb-Free)	50 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

MJF44H11 (NPN), MJF45H11 (PNP)

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage ($I_C = 30 \text{ mA}, I_B = 0$)	$V_{CEO(\text{sus})}$	80	—	—	Vdc
Collector Cutoff Current ($V_{CE} = \text{Rated } V_{CEO}, V_{BE} = 0$)	I_{CES}	—	—	1.0	μA
Emitter Cutoff Current ($V_{EB} = 5 \text{ Vdc}$)	I_{EBO}	—	—	10	μA
ON CHARACTERISTICS					
Collector-Emitter Saturation Voltage ($I_C = 8 \text{ Adc}, I_B = 0.4 \text{ Adc}$)	$V_{CE(\text{sat})}$	—	—	1.0	Vdc
Base-Emitter Saturation Voltage ($I_C = 8 \text{ Adc}, I_B = 0.8 \text{ Adc}$)	$V_{BE(\text{sat})}$	—	—	1.5	Vdc
DC Current Gain ($V_{CE} = 1 \text{ Vdc}, I_C = 2 \text{ Adc}$)	h_{FE}	60	—	—	—
DC Current Gain ($V_{CE} = 1 \text{ Vdc}, I_C = 4 \text{ Adc}$)		40	—	—	
DYNAMIC CHARACTERISTICS					
Collector Capacitance ($V_{CB} = 10 \text{ Vdc}, f_{\text{test}} = 1 \text{ MHz}$)	MJF44H11 MJF45H11	C_{cb}	—	130	—
Gain Bandwidth Product ($I_C = 0.5 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz}$)		f_T	—	230	—
Gain Bandwidth Product ($I_C = 0.5 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz}$)	MJF44H11 MJF45H11	f_T	—	50	—
Delay and Rise Times ($I_C = 5 \text{ Adc}, I_{B1} = 0.5 \text{ Adc}$)		$t_d + t_r$	—	135	ns
Storage Time ($I_C = 5 \text{ Adc}, I_{B1} = I_{B2} = 0.5 \text{ Adc}$)	MJF44H11 MJF45H11	t_s	—	500	ns
Fall Time ($I_C = 5 \text{ Adc}, I_{B1} = I_{B2} = 0.5 \text{ Adc}$)		t_f	—	500	ns
Fall Time ($I_C = 5 \text{ Adc}, I_{B1} = I_{B2} = 0.5 \text{ Adc}$)	MJF44H11 MJF45H11	t_f	—	140	ns

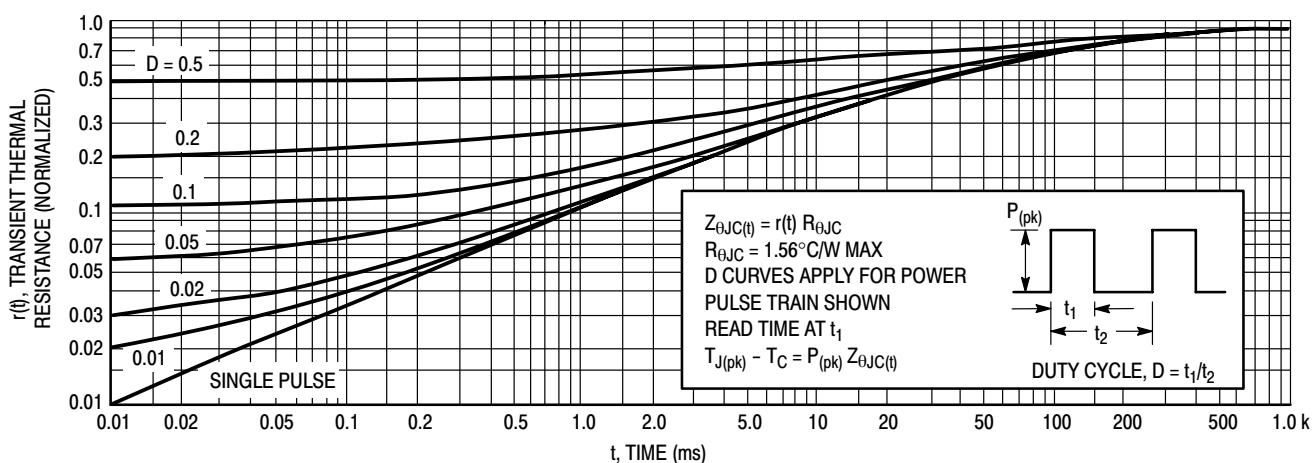
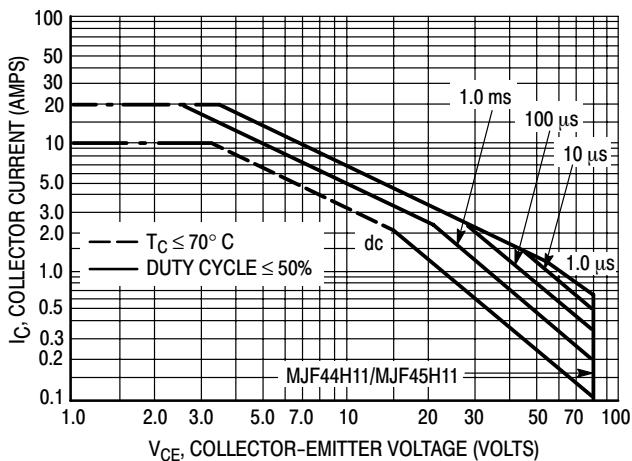


Figure 1. Thermal Response

MJF44H11 (NPN), MJF45H11 (PNP)



**Figure 2. Maximum Rated Forward Bias
Safe Operating Area**

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_{J(pk)} = 150^\circ\text{C}$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150^\circ\text{C}$. $T_{J(pk)}$ may be calculated from the data in Figure 1. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

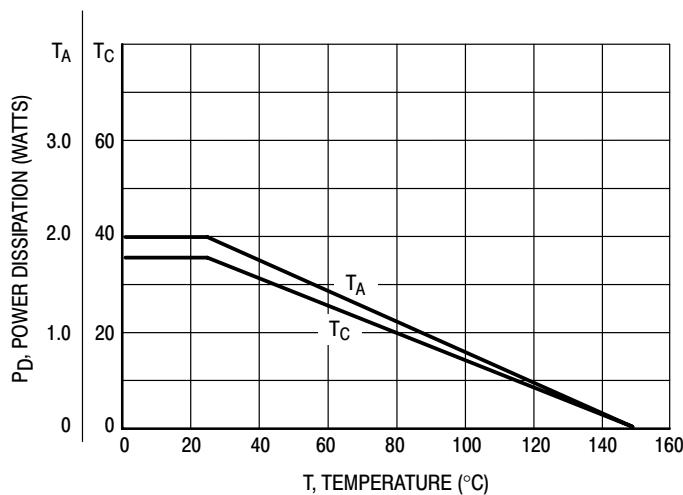


Figure 3. Power Derating

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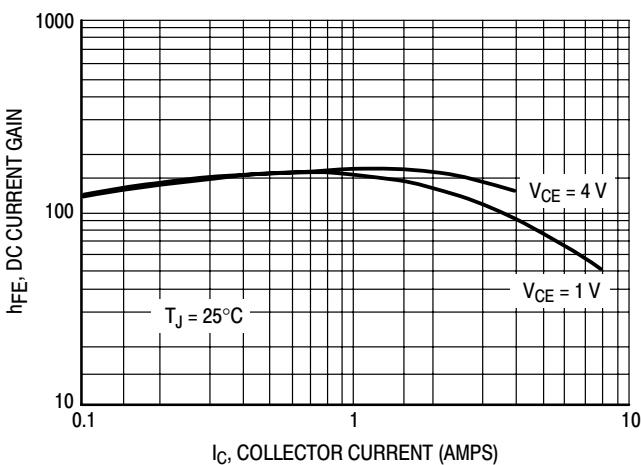


Figure 4. MJF44H11 DC Current Gain

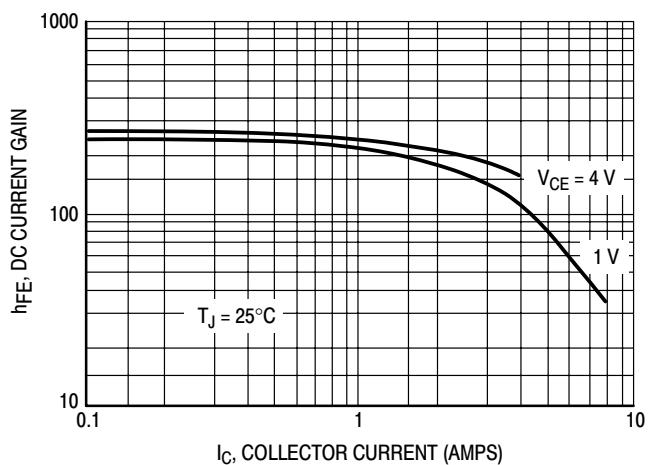


Figure 5. MJF45H11 DC Current Gain

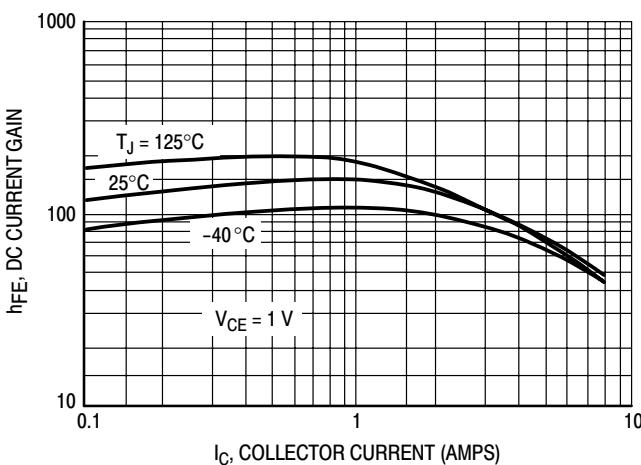


Figure 6. MJF44H11 Current Gain versus Temperature

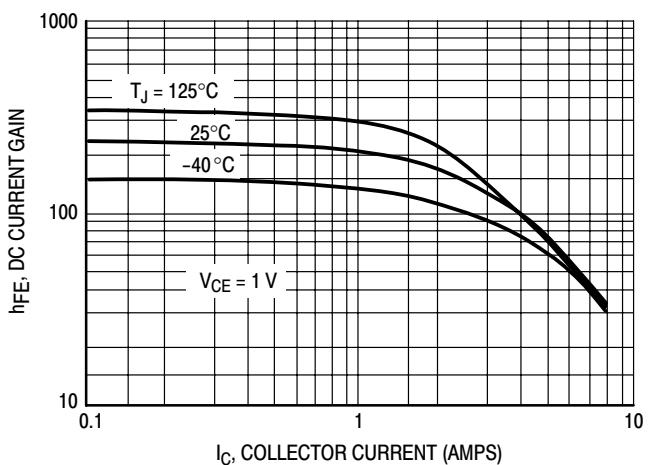


Figure 7. MJF45H11 Current Gain versus Temperature

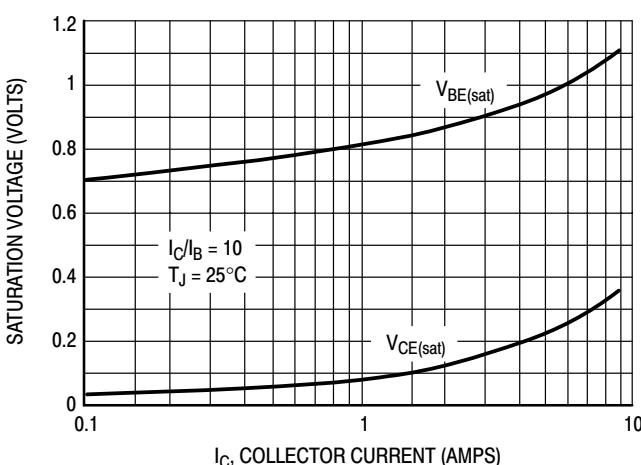


Figure 8. MJF44H11 On–Voltages

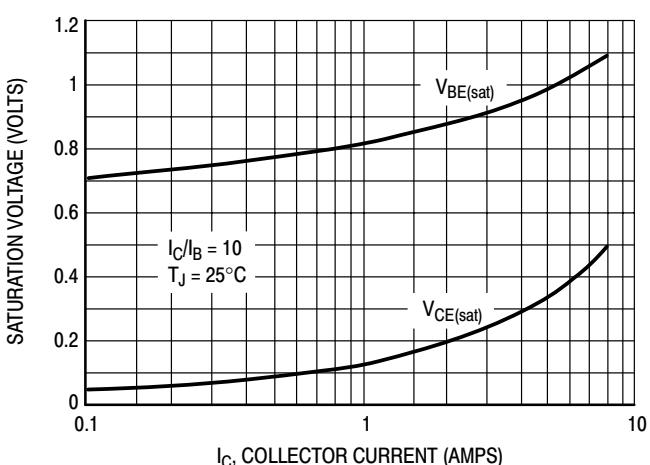
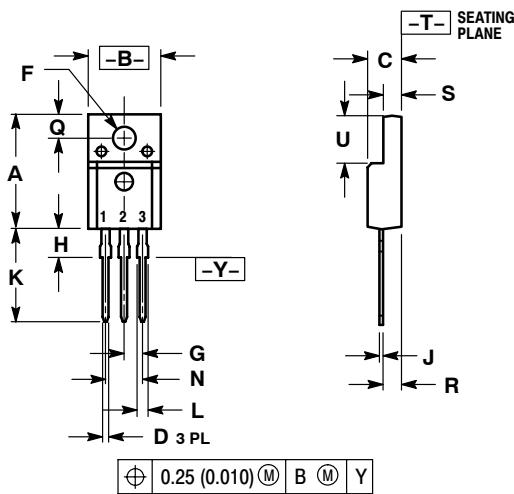


Figure 9. MJF45H11 On–Voltages

MJF44H11 (NPN), MJF45H11 (PNP)

PACKAGE DIMENSIONS

TO-220 FULLPAK CASE 221D-03 ISSUE G



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.625	0.635	15.88	16.12
B	0.408	0.418	10.37	10.63
C	0.180	0.190	4.57	4.83
D	0.026	0.031	0.65	0.78
F	0.116	0.119	2.95	3.02
G	0.100	BSC	2.54	BSC
H	0.125	0.135	3.18	3.43
J	0.018	0.025	0.45	0.63
K	0.530	0.540	13.47	13.73
L	0.048	0.053	1.23	1.36
N	0.200	BSC	5.08	BSC
Q	0.124	0.128	3.15	3.25
R	0.099	0.103	2.51	2.62
S	0.101	0.113	2.57	2.87
U	0.238	0.258	6.06	6.56

- STYLE 2:
 PIN 1. BASE
 2. COLLECTOR
 3. Emitter

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